Chapter 2 Overview of Power Semiconductor Devices

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Diodes

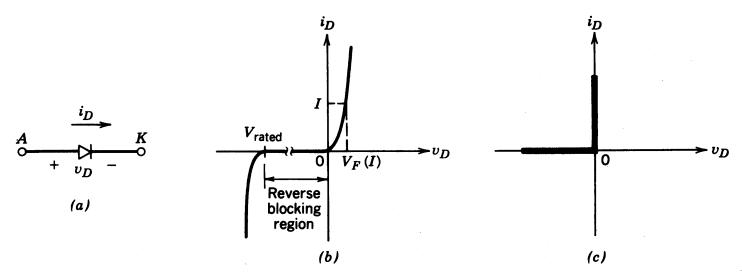


Figure 2-1 Diode: (a) symbol, (b) i-v characteristic, (c) idealized characteristic.

On and off states controlled by the power circuit

Diode Turn-Off

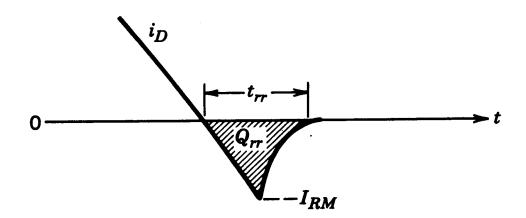


Figure 2-2 Diode turn-off.

• Fast-recovery diodes have a small reverse-recovery time

Thyristors

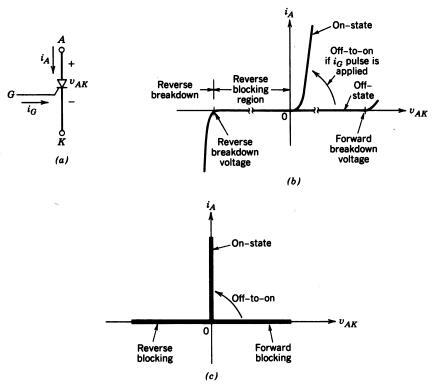


Figure 2-3 Thyristor: (a) symbol, (b) i-v characteristics, (c) idealized characteristics.

- Semi-controlled device
- Latches ON by a gate-current pulse if forward biased
- Turns-off if current tries to reverse

Thyristor in a Simple Circuit

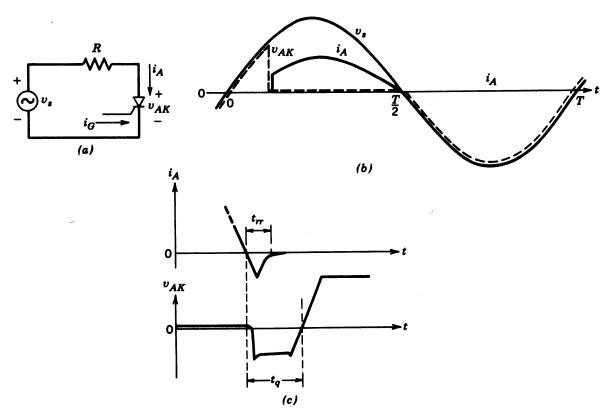


Figure 2-4 Thyristor: (a) circuit, (b) waveforms, (c) turn-off time interval t_q .

 For successful turn-off, reverse voltage required for an interval greater than the turn-off interval

Generic Switch Symbol

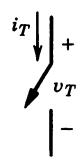
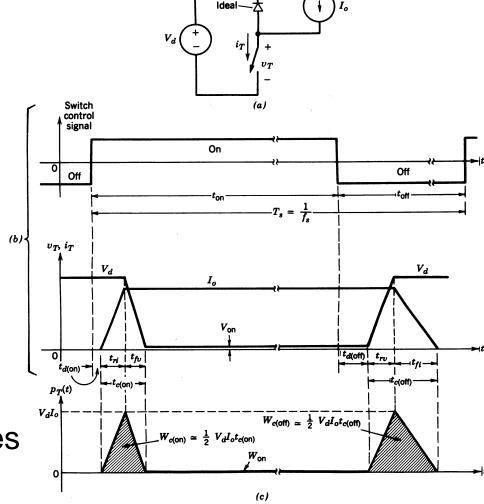


Figure 2-5 Generic controllable switch.

- Idealized switch symbol
- When on, current can flow only in the direction of the arrow
- Instantaneous switching from one state to the other
- Zero voltage drop in on-state
- Infinite voltage and current handling capabilities

Switching Characteristics (linearized)



(c)

Figure 2-6 Generic-switch switching characteristics (linearized): (a) simplified clamped-

inductive-switching circuit, (b) switch waveforms, (c) instantaneous switch power loss.

Switching Power Loss is proportional to:

- switching frequency
- turn-on and turn-off times

Bipolar Junction Transistors (BJT)

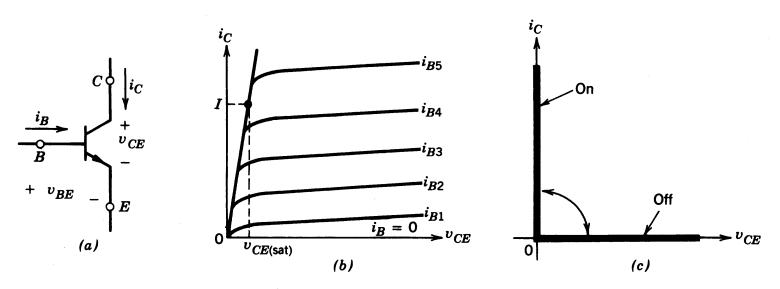


Figure 2-7 A BJT: (a) symbol, (b) i-v characteristics, (c) idealized characteristics.

- Used commonly in the past
- Now used in specific applications
- Replaced by MOSFETs and IGBTs

Various Configurations of BJTs

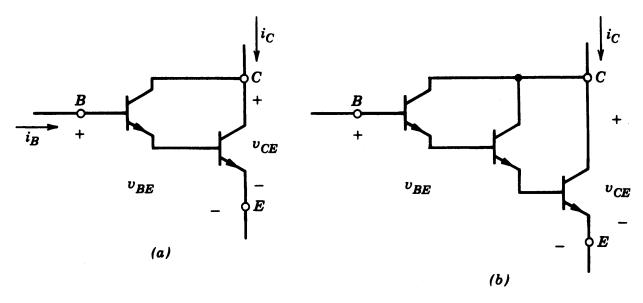


Figure 2-8 Darlington configurations: (a) Darlington, (b) triple Darlington.

MOSFETs

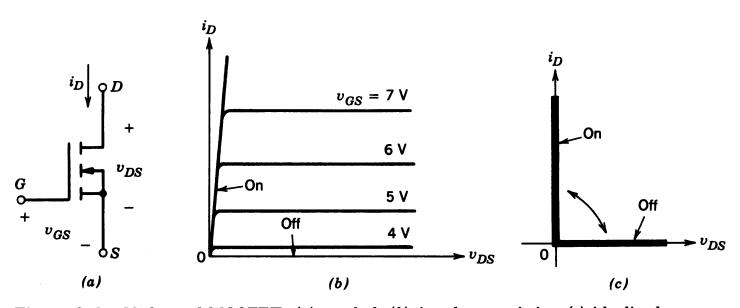


Figure 2-9 N-channel MOSFET: (a) symbol, (b) i-v characteristics, (c) idealized characteristics.

- Easy to control by the gate
- Optimal for low-voltage operation at high switching frequencies
- On-state resistance a concern at higher voltage ratings

Gate-Turn-Off Thyristors (GTO)

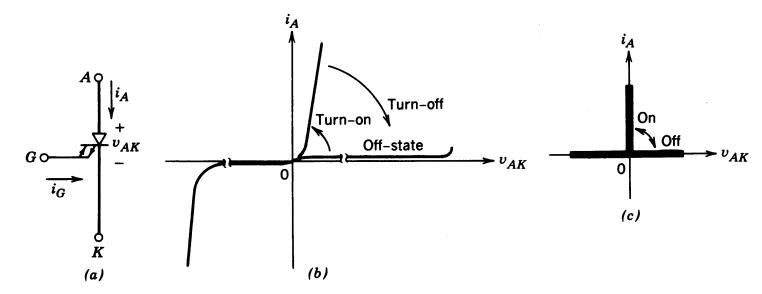


Figure 2-10 A GTO: (a) symbol, (b) i-v characteristics, (c) idealized characteristics.

- Slow switching speeds
- Used at very high power levels
- Require elaborate gate control circuitry

GTO Turn-Off

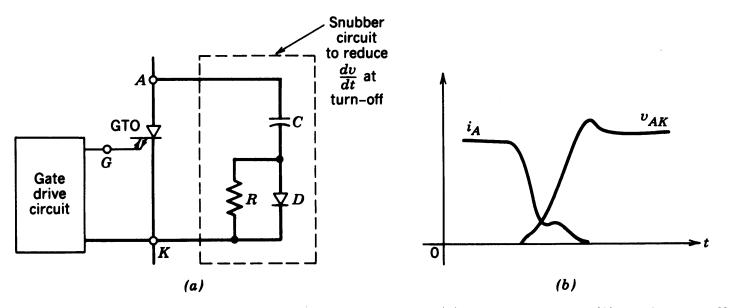


Figure 2-11 Gate turn-off transient characteristics: (a) snubber circuit, (b) GTO turn-off characteristic.

Need a turn-off snubber

IGBT

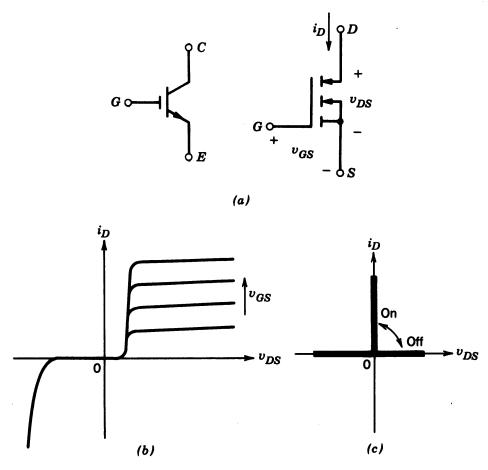


Figure 2-12 An IGBT: (a) symbol, (b) i-v characteristics, (c) idealized characteristics.

MCT

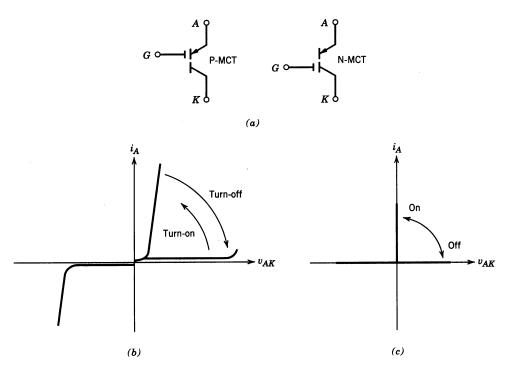


Figure 2-13 An MCT: (a) circuit symbols, (b) i-v characteristic, (c) idealized characteristics.

Comparison of Controllable Switches

Table 2-1 Relative Properties of Controllable Switches

Device	Power Capability	Switching Speed
BJT/MD	Medium	Medium
MOSFET	Low	Fast
GTO	High	Slow
IGBT	Medium	Medium
MCT	Medium	Medium

Summary of Device Capabilities

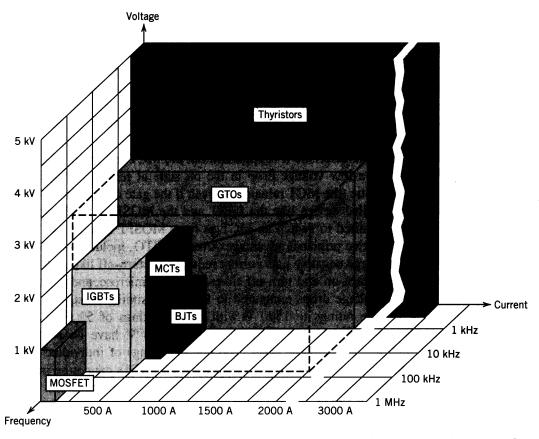


Figure 2-14 Summary of power semiconductor device capabilities. All devices except the MCT have a relatively mature technology, and only evolutionary improvements in the device capabilities are anticipated in the next few years. However, MCT technology is in a state of rapid expansion, and significant improvements in the device capabilities are possible, as indicated by the expansion arrow in the diagram.